

General Description

The SJ010N170 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

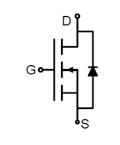
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	100	V
R _{DS(ON)_TYP}	14.7	mΩ
ID	60	А
Q _G	110	nC







Schematic Diagram

TO-220 top view

Package Marking and Ordering Information

	Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
	SJ010N170	SJ010N170	TO-220	Tube	١	/	1000 Pcs

Table 1. Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	100	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±20	V
Drain Current-Continuous(Tc=25°C)		60	А
Ι _D	Drain Current-Continuous(Tc=100℃)	38	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	t-Pulsed (Note 1) 240	
D-	Maximum Power Dissipation(Tc=25°C)	147	W
PD	Maximum Power Dissipation(Tc=100°C)	59	W
Eas	Avalanche energy (Note 2)	210	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case		0.85	°C/W



Table 3. Electrical Characteristics (T_J=25 $^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250µA	100			V
	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V T _J =25℃			1	μA
IDSS		V _{DS} =100V, V _{GS} =0V T _J =125℃			100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1		2.5	V
g fs	Forward Transconductance	V _{DS} =10V, I _D =20A		45		S
Rds(on)	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A T _J =25℃		14.7	18.4	mΩ
Rds(on)	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =20A T _J =25℃		15.5	20.2	mΩ
Dynamic Chara	acteristics				L	
Ciss	Input Capacitance			5180		pF
Coss	Output Capacitance	V _{DS} =50V,V _{GS} =0V, f=1.0MHz		126		pF
Crss	Reverse Transfer Capacitance			118		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		0.74		Ω
Switching Para	imeters			1	L	
t _{d(on)}	Turn-on Delay Time			11		nS
tr	Turn-on Rise Time	V _{GS} =10V, V _{DS} =50V, R _L =2.5Ω, R _{GEN} =6Ω		20		nS
t _{d(off)}	Turn-Off Delay Time			25		nS
t _f	Turn-Off Fall Time			20		nS
Qg	Total Gate Charge			110		nC
Q_{gs}	Gate-Source Charge	V _{GS} =10V, V _{DS} =50V, I _D =20A		29.5		nC
Q_{gd}	Gate-Drain Charge	-		28		nC
Source-Drain D	Diode Characteristics			1	L	
I _{SD}	Source-Drain Current (Body Diode)				60	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
t _{rr}	Reverse Recovery Time	l⊧=20A, dl/dt=100A/μs		48		ns
Qrr	Reverse Recovery Charge	I⊧=20A, dI/dt=100A/μs		80		nC

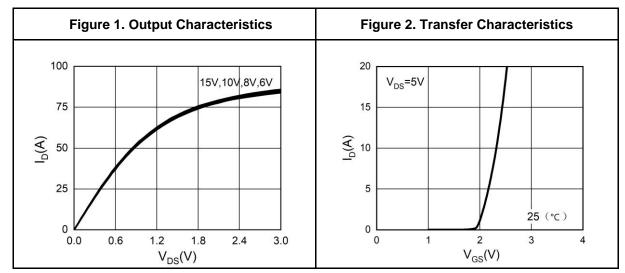
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

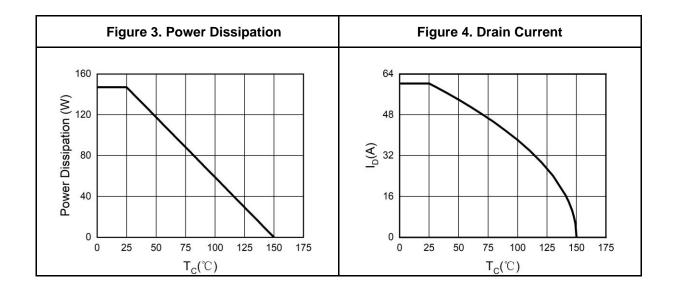
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=50V$, $V_G=10V$, $Rg=25\Omega$, L=0.5mH.

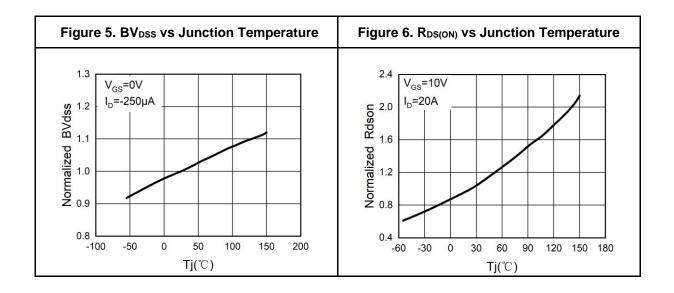
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



Typical Electrical And Thermal Characteristics (Curves)





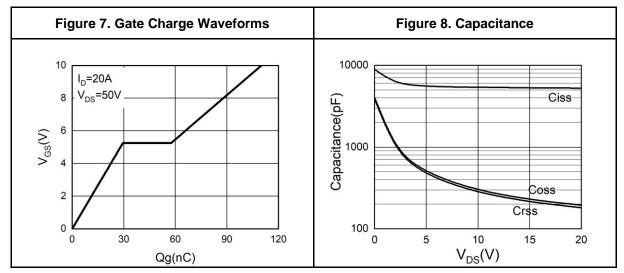


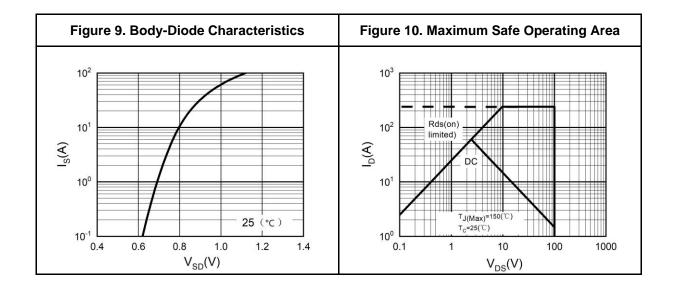


SJ010N170

100V N-Channel Trench Power MOSFET

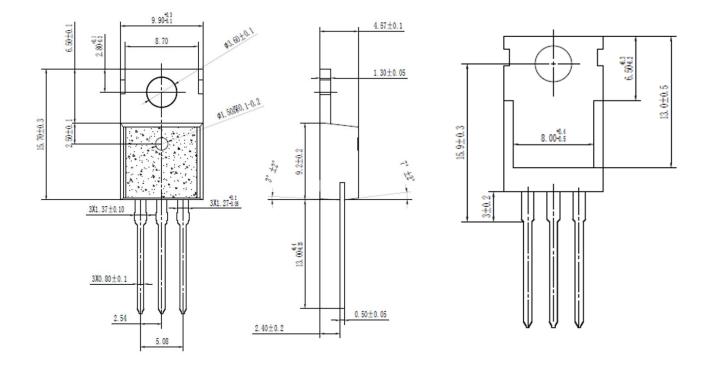
Typical Electrical And Thermal Characteristics (Curves)







TO-220 Package Information





Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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